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Understanding <u>Embedded - FPGAs (Field Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	1152
Number of Logic Elements/Cells	11520
Total RAM Bits	147456
Number of I/O	-
Number of Gates	728000
Voltage - Supply	1.71V ~ 1.89V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	208-BFQFP Exposed Pad
Supplier Device Package	208-RQFP (28x28)
Purchase URL	https://www.e-xfl.com/product-detail/intel/ep20k300erc208-3

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

Table 5. APEX 20K FineLine BGA Package Options & I/O Count Notes (1), (2)					
Device	144 Pin	324 Pin	484 Pin	672 Pin	1,020 Pin
EP20K30E	93	128			
EP20K60E	93	196			
EP20K100		252			
EP20K100E	93	246			
EP20K160E			316		
EP20K200			382		
EP20K200E			376	376	
EP20K300E				408	
EP20K400				502 <i>(3)</i>	
EP20K400E				488 (3)	
EP20K600E				508 (3)	588
EP20K1000E				508 (3)	708
EP20K1500E					808

Notes to Tables 4 and 5:

- (1) I/O counts include dedicated input and clock pins.
- (2) APEX 20K device package types include thin quad flat pack (TQFP), plastic quad flat pack (PQFP), power quad flat pack (RQFP), 1.27-mm pitch ball-grid array (BGA), 1.00-mm pitch FineLine BGA, and pin-grid array (PGA) packages.
- (3) This device uses a thermally enhanced package, which is taller than the regular package. Consult the *Altera Device Package Information Data Sheet* for detailed package size information.

Table 6. APEX 20K QFP, BGA & PGA Package Sizes							
Feature	144-Pin TQFP	208-Pin QFP	240-Pin QFP	356-Pin BGA	652-Pin BGA	655-Pin PGA	
Pitch (mm)	0.50	0.50	0.50	1.27	1.27	_	
Area (mm ²)	484	924	1,218	1,225	2,025	3,906	
$\begin{array}{c} \text{Length} \times \text{Width} \\ \text{(mm} \times \text{mm)} \end{array}$	22 × 22	30.4 × 30.4	34.9 × 34.9	35 × 35	45 × 45	62.5 × 62.5	

Table 7. APEX 20K FineLine BGA Package Sizes							
Feature 144 Pin 324 Pin 484 Pin 672 Pin 1,020 Pin							
Pitch (mm)	1.00	1.00	1.00	1.00	1.00		
Area (mm ²)	169	361	529	729	1,089		
$Length \times Width (mm \times mm)$	13 × 13	19×19	23 × 23	27 × 27	33 × 33		

Table 10 describes the APEX 20K programmable delays and their logic options in the Quartus II software.

Table 10. APEX 20K Programmable Delay Chains			
Programmable Delays Quartus II Logic Option			
Input pin to core delay	Decrease input delay to internal cells		
Input pin to input register delay	Decrease input delay to input register		
Core to output register delay Decrease input delay to output register			
Output register t _{CO} delay	Increase delay to output pin		

The Quartus II software compiler can program these delays automatically to minimize setup time while providing a zero hold time. Figure 25 shows how fast bidirectional I/Os are implemented in APEX 20K devices.

The register in the APEX 20K IOE can be programmed to power-up high or low after configuration is complete. If it is programmed to power-up low, an asynchronous clear can control the register. If it is programmed to power-up high, the register cannot be asynchronously cleared or preset. This feature is useful for cases where the APEX 20K device controls an active-low input or another device; it prevents inadvertent activation of the input upon power-up.

Each IOE drives a row, column, MegaLAB, or local interconnect when used as an input or bidirectional pin. A row IOE can drive a local, MegaLAB, row, and column interconnect; a column IOE can drive the column interconnect. Figure 27 shows how a row IOE connects to the interconnect.

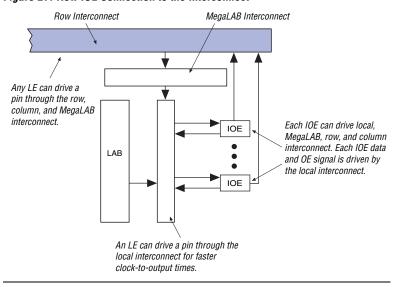


Figure 27. Row IOE Connection to the Interconnect

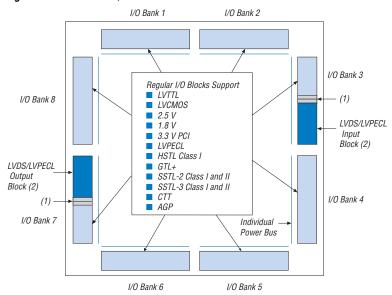


Figure 29. APEX 20KE I/O Banks

Notes to Figure 29:

- For more information on placing I/O pins in LVDS blocks, refer to the Guidelines for Using LVDS Blocks section in Application Note 120 (Using LVDS in APEX 20KE Devices).
- (2) If the LVDS input and output blocks are not used for LVDS, they can support all of the I/O standards and can be used as input, output, or bidirectional pins with V_{CCIO} set to 3.3 V, 2.5 V, or 1.8 V.

Power Sequencing & Hot Socketing

Because APEX 20K and APEX 20KE devices can be used in a mixed-voltage environment, they have been designed specifically to tolerate any possible power-up sequence. Therefore, the $V_{\rm CCIO}$ and $V_{\rm CCINT}$ power supplies may be powered in any order.



For more information, please refer to the "Power Sequencing Considerations" section in the *Configuring APEX 20KE & APEX 20KC Devices* chapter of the *Configuration Devices Handbook*.

Signals can be driven into APEX 20K devices before and during power-up without damaging the device. In addition, APEX 20K devices do not drive out during power-up. Once operating conditions are reached and the device is configured, APEX 20K and APEX 20KE devices operate as specified by the user.

For designs that require both a multiplied and non-multiplied clock, the clock trace on the board can be connected to CLK2p. Table 14 shows the combinations supported by the ClockLock and ClockBoost circuitry. The CLK2p pin can feed both the ClockLock and ClockBoost circuitry in the APEX 20K device. However, when both circuits are used, the other clock pin (CLK1p) cannot be used.

Table 14. Multiplication Factor Combinations			
Clock 1 Clock 2			
×1	×1		
×1,×2	×2		
×1, ×2, ×4	×4		

APEX 20KE ClockLock Feature

APEX 20KE devices include an enhanced ClockLock feature set. These devices include up to four PLLs, which can be used independently. Two PLLs are designed for either general-purpose use or LVDS use (on devices that support LVDS I/O pins). The remaining two PLLs are designed for general-purpose use. The EP20K200E and smaller devices have two PLLs; the EP20K300E and larger devices have four PLLs.

The following sections describe some of the features offered by the APEX 20KE PLLs.

External PLL Feedback

The ClockLock circuit's output can be driven off-chip to clock other devices in the system; further, the feedback loop of the PLL can be routed off-chip. This feature allows the designer to exercise fine control over the I/O interface between the APEX 20KE device and another high-speed device, such as SDRAM.

Clock Multiplication

The APEX 20KE ClockBoost circuit can multiply or divide clocks by a programmable number. The clock can be multiplied by $m/(n \times k)$ or $m/(n \times v)$, where m and k range from 2 to 160, and n and v range from 1 to 16. Clock multiplication and division can be used for time-domain multiplexing and other functions, which can reduce design LE requirements.

Clock Phase & Delay Adjustment

The APEX 20KE ClockShift feature allows the clock phase and delay to be adjusted. The clock phase can be adjusted by 90° steps. The clock delay can be adjusted to increase or decrease the clock delay by an arbitrary amount, up to one clock period.

LVDS Support

Two PLLs are designed to support the LVDS interface. When using LVDS, the I/O clock runs at a slower rate than the data transfer rate. Thus, PLLs are used to multiply the I/O clock internally to capture the LVDS data. For example, an I/O clock may run at 105 MHz to support 840 megabits per second (Mbps) LVDS data transfer. In this example, the PLL multiplies the incoming clock by eight to support the high-speed data transfer. You can use PLLs in EP20K400E and larger devices for high-speed LVDS interfacing.

Lock Signals

The APEX 20KE ClockLock circuitry supports individual LOCK signals. The LOCK signal drives high when the ClockLock circuit has locked onto the input clock. The LOCK signals are optional for each ClockLock circuit; when not used, they are I/O pins.

ClockLock & ClockBoost Timing Parameters

For the ClockLock and ClockBoost circuitry to function properly, the incoming clock must meet certain requirements. If these specifications are not met, the circuitry may not lock onto the incoming clock, which generates an erroneous clock within the device. The clock generated by the ClockLock and ClockBoost circuitry must also meet certain specifications. If the incoming clock meets these requirements during configuration, the APEX 20K ClockLock and ClockBoost circuitry will lock onto the clock during configuration. The circuit will be ready for use immediately after configuration. In APEX 20KE devices, the clock input standard is programmable, so the PLL cannot respond to the clock until the device is configured. The PLL locks onto the input clock as soon as configuration is complete. Figure 30 shows the incoming and generated clock specifications.



For more information on ClockLock and ClockBoost circuitry, see *Application Note 115: Using the ClockLock and ClockBoost PLL Features in APEX Devices*.

Table 18. APEX 20KE Clock Input & Output Parameters (Part 2 of 2) Note (1)							
Symbol	Parameter	I/O Standard	-1X Speed Grade		-2X Speed	d Grade	Units
			Min	Max	Min	Max	
f _{IN}	Input clock frequency	3.3-V LVTTL	1.5	290	1.5	257	MHz
		2.5-V LVTTL	1.5	281	1.5	250	MHz
		1.8-V LVTTL	1.5	272	1.5	243	MHz
		GTL+	1.5	303	1.5	261	MHz
		SSTL-2 Class	1.5	291	1.5	253	MHz
		SSTL-2 Class	1.5	291	1.5	253	MHz
		SSTL-3 Class	1.5	300	1.5	260	MHz
		SSTL-3 Class	1.5	300	1.5	260	MHz
		LVDS	1.5	420	1.5	350	MHz

Notes to Tables 17 and 18:

- All input clock specifications must be met. The PLL may not lock onto an incoming clock if the clock specifications
 are not met, creating an erroneous clock within the device.
- (2) The maximum lock time is 40 µs or 2000 input clock cycles, whichever occurs first.
- (3) Before configuration, the PLL circuits are disable and powered down. During configuration, the PLLs are still disabled. The PLLs begin to lock once the device is in the user mode. If the clock enable feature is used, lock begins once the CLKLK ENA pin goes high in user mode.
- (4) The PLL VCO operating range is 200 MHz δ f_{VCO} δ 840 MHz for LVDS mode.

SignalTap Embedded Logic Analyzer

APEX 20K devices include device enhancements to support the SignalTap embedded logic analyzer. By including this circuitry, the APEX 20K device provides the ability to monitor design operation over a period of time through the IEEE Std. 1149.1 (JTAG) circuitry; a designer can analyze internal logic at speed without bringing internal signals to the I/O pins. This feature is particularly important for advanced packages such as FineLine BGA packages because adding a connection to a pin during the debugging process can be difficult after a board is designed and manufactured.

The APEX 20K device instruction register length is 10 bits. The APEX 20K device USERCODE register length is 32 bits. Tables 20 and 21 show the boundary-scan register length and device IDCODE information for APEX 20K devices.

Table 20. APEX 20K Boundary-Scan Register Length			
Device	Boundary-Scan Register Length		
EP20K30E	420		
EP20K60E	624		
EP20K100	786		
EP20K100E	774		
EP20K160E	984		
EP20K200	1,176		
EP20K200E	1,164		
EP20K300E	1,266		
EP20K400	1,536		
EP20K400E	1,506		
EP20K600E	1,806		
EP20K1000E	2,190		
EP20K1500E	1 (1)		

Note to Table 20:

(1) This device does not support JTAG boundary scan testing.

Table 22 shows the JTAG timing parameters and values for APEX 20K devices

Table 22. APEX 20K JTAG Timing Parameters & Values					
Symbol	Parameter	Min	Max	Unit	
t _{JCP}	TCK clock period	100		ns	
t _{JCH}	TCK clock high time	50		ns	
t_{JCL}	TCK clock low time	50		ns	
t _{JPSU}	JTAG port setup time	20		ns	
t _{JPH}	JTAG port hold time	45		ns	
t _{JPCO}	JTAG port clock to output		25	ns	
t _{JPZX}	JTAG port high impedance to valid output		25	ns	
t _{JPXZ}	JTAG port valid output to high impedance		25	ns	
t _{JSSU}	Capture register setup time	20		ns	
t _{JSH}	Capture register hold time	45		ns	
t _{JSCO}	Update register clock to output		35	ns	
t _{JSZX}	Update register high impedance to valid output		35	ns	
t _{JSXZ}	Update register valid output to high impedance		35	ns	



For more information, see the following documents:

- Application Note 39 (IEEE Std. 1149.1 (JTAG) Boundary-Scan Testing in Altera Devices)
- Jam Programming & Test Language Specification

Generic Testing

Each APEX 20K device is functionally tested. Complete testing of each configurable static random access memory (SRAM) bit and all logic functionality ensures 100% yield. AC test measurements for APEX 20K devices are made under conditions equivalent to those shown in Figure 32. Multiple test patterns can be used to configure devices during all stages of the production flow.

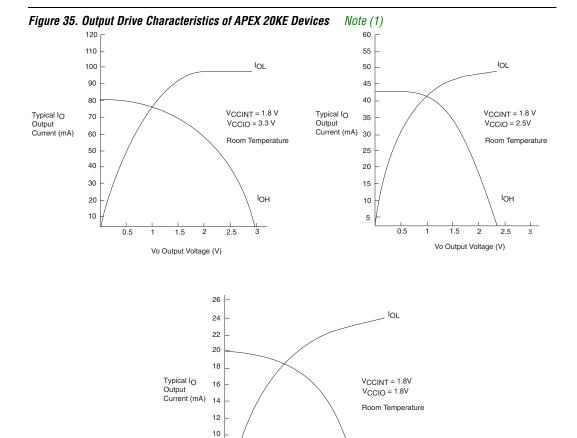
Table 2	Table 26. APEX 20K 5.0-V Tolerant Device Capacitance Notes (2), (14)					
Symbol	Parameter	Conditions	Min	Max	Unit	
C _{IN}	Input capacitance	V _{IN} = 0 V, f = 1.0 MHz		8	pF	
C _{INCLK}	Input capacitance on dedicated clock pin	V _{IN} = 0 V, f = 1.0 MHz		12	pF	
C _{OUT}	Output capacitance	V _{OUT} = 0 V, f = 1.0 MHz		8	pF	

Notes to Tables 23 through 26:

- (1) See the Operating Requirements for Altera Devices Data Sheet.
- (2) All APEX 20K devices are 5.0-V tolerant.
- (3) Minimum DC input is -0.5 V. During transitions, the inputs may undershoot to -2.0 V or overshoot to 5.75 V for input currents less than 100 mA and periods shorter than 20 ns.
- (4) Numbers in parentheses are for industrial-temperature-range devices.
- (5) Maximum V_{CC} rise time is 100 ms, and V_{CC} must rise monotonically.
- (6) All pins, including dedicated inputs, clock I/O, and JTAG pins, may be driven before V_{CCINT} and V_{CCIO} are powered.
- (7) Typical values are for $T_A = 25^{\circ}$ C, $V_{CCINT} = 2.5$ V, and $V_{CCIO} = 2.5$ or 3.3 V.
- (8) These values are specified in the APEX 20K device recommended operating conditions, shown in Table 26 on page 62.
- (9) The APEX 20K input buffers are compatible with 2.5-V and 3.3-V (LVTTL and LVCMOS) signals. Additionally, the input buffers are 3.3-V PCI compliant when V_{CCIO} and V_{CCINT} meet the relationship shown in Figure 33 on page 68.
- (10) The I_{OH} parameter refers to high-level TTL, PCI or CMOS output current.
- (11) The I_{OL} parameter refers to low-level TTL, PCI, or CMOS output current. This parameter applies to open-drain pins as well as output pins.
- (12) This value is specified for normal device operation. The value may vary during power-up.
- (13) Pin pull-up resistance values will be lower if an external source drives the pin higher than V_{CCIO} .
- (14) Capacitance is sample-tested only.

Tables 27 through 30 provide information on absolute maximum ratings, recommended operating conditions, DC operating conditions, and capacitance for 1.8-V APEX 20KE devices.

Table 27. APEX 20KE Device Absolute Maximum Ratings Note (1)						
Symbol	Parameter	Conditions	Min	Max	Unit	
V _{CCINT}	Supply voltage	With respect to ground (2)	-0.5	2.5	V	
V_{CCIO}			-0.5	4.6	٧	
V _I	DC input voltage		-0.5	4.6	V	
I _{OUT}	DC output current, per pin		-25	25	mA	
T _{STG}	Storage temperature	No bias	-65	150	° C	
T _{AMB}	Ambient temperature	Under bias	-65	135	° C	
TJ	Junction temperature	PQFP, RQFP, TQFP, and BGA packages, under bias		135	° C	
		Ceramic PGA packages, under bias		150	° C	



8

4 2

0.5

Figure 35 shows the output drive characteristics of APEX 20KE devices.

Note to Figure 35:

(1) These are transient (AC) currents.

Timing Model

The high-performance FastTrack and MegaLAB interconnect routing resources ensure predictable performance, accurate simulation, and accurate timing analysis. This predictable performance contrasts with that of FPGAs, which use a segmented connection scheme and therefore have unpredictable performance.

Vo Output Voltage (V)

IOH

2.0

Table 31. APEX 20K f _{MAX} Timing Parameters (Part 2 of 2)				
Symbol	Parameter			
t _{ESBDATACO2}	ESB clock-to-output delay without output registers			
t _{ESBDD}	ESB data-in to data-out delay for RAM mode			
t _{PD}	ESB macrocell input to non-registered output	-		
t _{PTERMSU}	ESB macrocell register setup time before clock			
t _{PTERMCO}	ESB macrocell register clock-to-output delay	-		
t _{F1-4}	Fanout delay using local interconnect	Fanout delay using local interconnect		
t _{F5-20}	Fanout delay using MegaLab Interconnect			
t _{F20+}	Fanout delay using FastTrack Interconnect			
t _{CH}	Minimum clock high time from clock pin			
t _{CL}	Minimum clock low time from clock pin			
t _{CLRP}	LE clear pulse width			
t _{PREP}	LE preset pulse width			
t _{ESBCH}	Clock high time			
t _{ESBCL}	Clock low time			
t _{ESBWP}	Write pulse width			
t _{ESBRP}	Read pulse width			

Tables 32 and 33 describe APEX 20K external timing parameters.

Table 32. APEX 20K External Timing Parameters Note (1)					
Symbol	Clock Parameter				
t _{INSU}	Setup time with global clock at IOE register				
t _{INH}	Hold time with global clock at IOE register				
tоитсо	Clock-to-output delay with global clock at IOE register				

Table 33. APEX 20K External Bidirectional Timing Parameters Note (1)									
Symbol	Symbol Parameter								
t _{INSUBIDIR}	Setup time for bidirectional pins with global clock at same-row or same-column LE register								
t _{INHBIDIR}	Hold time for bidirectional pins with global clock at same-row or same-column LE register								
^t OUTCOBIDIR	Clock-to-output delay for bidirectional pins with global clock at IOE register	C1 = 10 pF							
t _{XZBIDIR}	Synchronous IOE output buffer disable delay	C1 = 10 pF							
t _{ZXBIDIR}	Synchronous IOE output buffer enable delay, slow slew rate = off	C1 = 10 pF							

Note to Tables 32 and 33:

(1) These timing parameters are sample-tested only.

Tables 34 through 37 show APEX 20KE LE, ESB, routing, and functional timing microparameters for the f_{MAX} timing model.

Table 34. APEX 20KE LE Timing Microparameters							
Symbol Parameter							
t _{SU}	LE register setup time before clock						
t _H	LE register hold time after clock						
t _{CO}	LE register clock-to-output delay						
t _{LUT}	LUT delay for data-in to data-out						

Table 35. APE.	X 20KE ESB Timing Microparameters
Symbol	Parameter
t _{ESBARC}	ESB Asynchronous read cycle time
t _{ESBSRC}	ESB Synchronous read cycle time
t _{ESBAWC}	ESB Asynchronous write cycle time
t _{ESBSWC}	ESB Synchronous write cycle time
t _{ESBWASU}	ESB write address setup time with respect to WE
t _{ESBWAH}	ESB write address hold time with respect to WE
t _{ESBWDSU}	ESB data setup time with respect to WE
t _{ESBWDH}	ESB data hold time with respect to WE
t _{ESBRASU}	ESB read address setup time with respect to RE
t _{ESBRAH}	ESB read address hold time with respect to RE
t _{ESBWESU}	ESB WE setup time before clock when using input register
t _{ESBWEH}	ESB WE hold time after clock when using input register
t _{ESBDATASU}	ESB data setup time before clock when using input register
t _{ESBDATAH}	ESB data hold time after clock when using input register
t _{ESBWADDRSU}	ESB write address setup time before clock when using input registers
t _{ESBRADDRSU}	ESB read address setup time before clock when using input registers
t _{ESBDATACO1}	ESB clock-to-output delay when using output registers
t _{ESBDATACO2}	ESB clock-to-output delay without output registers
t _{ESBDD}	ESB data-in to data-out delay for RAM mode
t _{PD}	ESB Macrocell input to non-registered output
t _{PTERMSU}	ESB Macrocell register setup time before clock
t _{PTERMCO}	ESB Macrocell register clock-to-output delay

Table 43. EP20K100 External Timing Parameters									
Symbol	-1 Spe	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade			
	Min	Max	Min	Max	Min	Max	1		
t _{INSU} (1)	2.3		2.8		3.2		ns		
t _{INH} (1)	0.0		0.0		0.0		ns		
t _{OUTCO} (1)	2.0	4.5	2.0	4.9	2.0	6.6	ns		
t _{INSU} (2)	1.1		1.2		-		ns		
t _{INH} (2)	0.0		0.0		-		ns		
t _{OUTCO} (2)	0.5	2.7	0.5	3.1	_	4.8	ns		

Symbol	-1 Spee	ed Grade	-2 Spee	-2 Speed Grade		d Grade	Unit
	Min	Max	Min	Max	Min	Max	1
t _{INSUBIDIR} (1)	2.3		2.8		3.2		ns
t _{INHBIDIR} (1)	0.0		0.0		0.0		ns
toutcobidir (1)	2.0	4.5	2.0	4.9	2.0	6.6	ns
t _{XZBIDIR} (1)		5.0		5.9		6.9	ns
t _{ZXBIDIR} (1)		5.0		5.9		6.9	ns
t _{INSUBIDIR} (2)	1.0		1.2		-		ns
t _{INHBIDIR} (2)	0.0		0.0		-		ns
toutcobidir (2)	0.5	2.7	0.5	3.1	-	-	ns
t _{XZBIDIR} (2)		4.3		5.0		_	ns
t _{ZXBIDIR} (2)		4.3		5.0		_	ns

Table 45. EP20K200 External Timing Parameters									
Symbol	-1 Spec	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade			
	Min	Max	Min	Max	Min	Max			
t _{INSU} (1)	1.9		2.3		2.6		ns		
t _{INH} (1)	0.0		0.0		0.0		ns		
t _{OUTCO} (1)	2.0	4.6	2.0	5.6	2.0	6.8	ns		
t _{INSU} (2)	1.1		1.2		-		ns		
t _{INH} (2)	0.0		0.0		-		ns		
t _{оитсо} <i>(2)</i>	0.5	2.7	0.5	3.1	-	_	ns		

Symbol	-1 Spee	d Grade	-2 Spee	-2 Speed Grade		d Grade	Unit
	Min	Max	Min	Max	Min	Max	
t _{INSUBIDIR} (1)	1.9		2.3		2.6		ns
t _{INHBIDIR} (1)	0.0		0.0		0.0		ns
t _{OUTCOBIDIR} (1)	2.0	4.6	2.0	5.6	2.0	6.8	ns
t _{XZBIDIR} (1)		5.0		5.9		6.9	ns
t _{ZXBIDIR} (1)		5.0		5.9		6.9	ns
t _{INSUBIDIR} (2)	1.1		1.2		-		ns
t _{INHBIDIR} (2)	0.0		0.0		-		ns
t _{OUTCOBIDIR} (2)	0.5	2.7	0.5	3.1	-	_	ns
t _{XZBIDIR} (2)		4.3		5.0		_	ns
t _{ZXBIDIR} (2)		4.3		5.0		_	ns

Table 47. EP20K400 External Timing Parameters								
Symbol	-1 Spee	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		
	Min	Max	Min	Max	Min	Max	1	
t _{INSU} (1)	1.4		1.8		2.0		ns	
t _{INH} (1)	0.0		0.0		0.0		ns	
t _{OUTCO} (1)	2.0	4.9	2.0	6.1	2.0	7.0	ns	
t _{INSU} (2)	0.4		1.0		-		ns	
t _{INH} (2)	0.0		0.0		_		ns	
t _{OUTCO} (2)	0.5	3.1	0.5	4.1	_	_	ns	

Table 48. EP20K400 External Bidirectional Ti	imina	Parameters 4 8 1
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Symbol -1 Speed Grad		d Grade	-2 Spee	ed Grade	-3 Spe	Unit	
	Min	Max	Min	Max	Min	Max	
t _{INSUBIDIR} (1)	1.4		1.8		2.0		ns
t _{INHBIDIR} (1)	0.0		0.0		0.0		ns
t _{OUTCOBIDIR} (1)	2.0	4.9	2.0	6.1	2.0	7.0	ns
t _{XZBIDIR} (1)		7.3		8.9		10.3	ns
t _{ZXBIDIR} (1)		7.3		8.9		10.3	ns
t _{INSUBIDIR} (2)	0.5		1.0		-		ns
t _{INHBIDIR} (2)	0.0		0.0		-		ns
toutcobidir (2)	0.5	3.1	0.5	4.1	-	-	ns
t _{XZBIDIR} (2)		6.2		7.6		-	ns
t _{ZXBIDIR} (2)		6.2		7.6		_	ns

Symbol	-	1		-2	-;	3	Unit
	Min	Max	Min	Max	Min	Max	
t _{ESBARC}		1.83		2.57		3.79	ns
t _{ESBSRC}		2.46		3.26		4.61	ns
t _{ESBAWC}		3.50		4.90		7.23	ns
t _{ESBSWC}		3.77		4.90		6.79	ns
t _{ESBWASU}	1.59		2.23		3.29		ns
t _{ESBWAH}	0.00		0.00		0.00		ns
t _{ESBWDSU}	1.75		2.46		3.62		ns
t _{ESBWDH}	0.00		0.00		0.00		ns
t _{ESBRASU}	1.76		2.47		3.64		ns
t _{ESBRAH}	0.00		0.00		0.00		ns
t _{ESBWESU}	1.68		2.49		3.87		ns
t _{ESBWEH}	0.00		0.00		0.00		ns
t _{ESBDATASU}	0.08		0.43		1.04		ns
t _{ESBDATAH}	0.13		0.13		0.13		ns
t _{ESBWADDRSU}	0.29		0.72		1.46		ns
t _{ESBRADDRSU}	0.36		0.81		1.58		ns
t _{ESBDATACO1}		1.06		1.24		1.55	ns
t _{ESBDATACO2}		2.39		3.35		4.94	ns
t _{ESBDD}		3.50		4.90		7.23	ns
t _{PD}		1.72		2.41		3.56	ns
t _{PTERMSU}	0.99		1.56		2.55		ns
t _{PTERMCO}		1.07		1.26		1.08	ns

Symbol	-1 Speed Grade		-2 Speed Grade		-3 Spee	Unit	
	Min	Max	Min	Max	Min	Max	
t _{ESBARC}		1.67		1.91		1.99	ns
t _{ESBSRC}		2.30		2.66		2.93	ns
t _{ESBAWC}		3.09		3.58		3.99	ns
t _{ESBSWC}		3.01		3.65		4.05	ns
t _{ESBWASU}	0.54		0.63		0.65		ns
t _{ESBWAH}	0.36		0.43		0.42		ns
t _{ESBWDSU}	0.69		0.77		0.84		ns
t _{ESBWDH}	0.36		0.43		0.42		ns
t _{ESBRASU}	1.61		1.77		1.86		ns
t _{ESBRAH}	0.00		0.00		0.01		ns
t _{ESBWESU}	1.35		1.47		1.61		ns
t _{ESBWEH}	0.00		0.00		0.00		ns
t _{ESBDATASU}	-0.18		-0.30		-0.27		ns
t _{ESBDATAH}	0.13		0.13		0.13		ns
t _{ESBWADDRSU}	-0.02		-0.11		-0.03		ns
t _{ESBRADDRSU}	0.06		-0.01		-0.05		ns
t _{ESBDATACO1}		1.16		1.40		1.54	ns
t _{ESBDATACO2}		2.18		2.55		2.85	ns
t _{ESBDD}		2.73		3.17		3.58	ns
t _{PD}		1.57		1.83		2.07	ns
t _{PTERMSU}	0.92		0.99		1.18		ns
t _{PTERMCO}		1.18		1.43		1.17	ns

Table 87. EP2	Table 87. EP20K400E f _{MAX} Routing Delays										
Symbol	-1 Spee	d Grade	-2 Spe	ed Grade	-3 Spee	Unit					
	Min	Max	Min	Max	Min	Max					
t _{F1-4}		0.25		0.25		0.26	ns				
t _{F5-20}		1.01		1.12		1.25	ns				
t _{F20+}		3.71		3.92		4.17	ns				

Table 88. EP20K400E Minimum Pulse Width Timing Parameters Symbol -1 Speed Grade -2 Speed Grade -3 Speed Grade Unit									
Symbol	-1 Spee	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade			
	Min	Max	Min	Max	Min	Max			
t _{CH}	1.36		2.22		2.35		ns		
t _{CL}	1.36		2.26		2.35		ns		
t _{CLRP}	0.18		0.18		0.19		ns		
t _{PREP}	0.18		0.18		0.19		ns		
t _{ESBCH}	1.36		2.26		2.35		ns		
t _{ESBCL}	1.36		2.26		2.35		ns		
t _{ESBWP}	1.17		1.38		1.56		ns		
t _{ESBRP}	0.94		1.09		1.25		ns		

Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
t _{INSU}	2.51		2.64		2.77		ns
t _{INH}	0.00		0.00		0.00		ns
t _{OUTCO}	2.00	5.25	2.00	5.79	2.00	6.32	ns
t _{INSUPLL}	3.221		3.38		=		ns
t _{INHPLL}	0.00		0.00		=		ns
t _{OUTCOPLL}	0.50	2.25	0.50	2.45	-	-	ns

Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit	
	Min	Max	Min	Max	Min	Max	1	
t _{ESBARC}		1.78		2.02		1.95	ns	
t _{ESBSRC}		2.52		2.91		3.14	ns	
t _{ESBAWC}		3.52		4.11		4.40	ns	
t _{ESBSWC}		3.23		3.84		4.16	ns	
t _{ESBWASU}	0.62		0.67		0.61		ns	
t _{ESBWAH}	0.41		0.55		0.55		ns	
t _{ESBWDSU}	0.77		0.79		0.81		ns	
t _{ESBWDH}	0.41		0.55		0.55		ns	
t _{ESBRASU}	1.74		1.92		1.85		ns	
t _{ESBRAH}	0.00		0.01		0.23		ns	
t _{ESBWESU}	2.07		2.28		2.41		ns	
t _{ESBWEH}	0.00		0.00		0.00		ns	
t _{ESBDATASU}	0.25		0.27		0.29		ns	
t _{ESBDATAH}	0.13		0.13		0.13		ns	
t _{ESBWADDRSU}	0.11		0.04		0.11		ns	
t _{ESBRADDRSU}	0.14		0.11		0.16		ns	
t _{ESBDATACO1}		1.29		1.50		1.63	ns	
t _{ESBDATACO2}		2.55		2.99		3.22	ns	
t _{ESBDD}		3.12		3.57		3.85	ns	
t _{PD}		1.84		2.13		2.32	ns	
t _{PTERMSU}	1.08		1.19		1.32	_	ns	
t _{PTERMCO}		1.31		1.53		1.66	ns	

Table 105. EP20K1500E f _{MAX} Routing Delays										
Symbol	-1 Spee	d Grade	-2 Spe	ed Grade	-3 Spee	Unit				
	Min	Max	Min	Max	Min	Max				
t _{F1-4}		0.28		0.28		0.28	ns			
t _{F5-20}		1.36		1.50		1.62	ns			
t _{F20+}		4.43		4.48		5.07	ns			

Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
t _{CH}	1.25		1.43		1.67		ns
t _{CL}	1.25		1.43		1.67		ns
t _{CLRP}	0.20		0.20		0.20		ns
t _{PREP}	0.20		0.20		0.20		ns
t _{ESBCH}	1.25		1.43		1.67		ns
t _{ESBCL}	1.25		1.43		1.67		ns
t _{ESBWP}	1.28		1.51		1.65		ns
t _{ESBRP}	1.11		1.29		1.41		ns

Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
t _{INSU}	3.09		3.30		3.58		ns
t _{INH}	0.00		0.00		0.00		ns
t _{OUTCO}	2.00	6.18	2.00	6.81	2.00	7.36	ns
t _{INSUPLL}	1.94		2.08		-		ns
t _{INHPLL}	0.00		0.00		-		ns
toutcople	0.50	2.67	0.50	2.99	-	-	ns